Triacs BT137X series

GENERAL DESCRIPTION

Passivated triacs in a full pack plastic envelope, intended for use in applications requiring high bidirectional transient and blocking voltage capability and high thermal cycling performance. Typical applications include motor control, industrial and domestic lighting, heating and static switching.

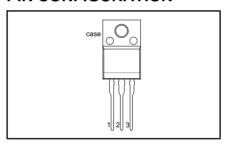
QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	MAX.	MAX.	UNIT
	BT137X- BT137X- BT137X-	500 500F 500G	600 600F 600G	800 800F 800G	
V_{DRM}	Repetitive peak off-state	500	600	800	V
I _{T(RMS)} I _{TSM}	voltages RMS on-state current Non-repetitive peak on-state current	8 65	8 65	8 65	A A

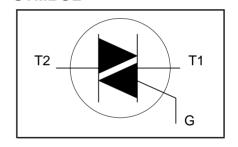
PINNING - SOT186A

Ī	PIN	DESCRIPTION				
	1	main terminal 1				
	2	main terminal 2				
	3	gate				
L	case	isolated				

PIN CONFIGURATION



SYMBOL



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

PARAMETER	CONDITIONS	MIN.		MAX.		UNIT
Repetitive peak off-state voltages		-	-500 500 ¹	-600 600 ¹	-800 800	V
RMS on-state current Non-repetitive peak on-state current	full sine wave; $T_{hs} \le 73 ^{\circ}\text{C}$ full sine wave; $T_{j} = 25 ^{\circ}\text{C}$ prior to surge	-		8		A
		-				A
I ² t for fusing	t = 10 ms	_		21		A A ² s
Repetitive rate of rise of on-state current after	$I_{TM} = 12 \text{ A}; I_G = 0.2 \text{ A};$ $dI_G/dt = 0.2 \text{ A}/\mu\text{s}$					
triggering		-				A/μs A/μs
	T2- G-	-		50		A/μs
Dools mate assument	T2- G+	-				A/μs
		-		<u> </u>		l A V
		_		5		ĺ w l
Average gate power Storage temperature Operating junction	over any 20 ms period	- -40 -		0.5 150 125		°C °C
	Repetitive peak off-state voltages RMS on-state current Non-repetitive peak on-state current I²t for fusing Repetitive rate of rise of on-state current after triggering Peak gate current Peak gate voltage Peak gate power Average gate power Storage temperature	Repetitive peak off-state voltages RMS on-state current Non-repetitive peak on-state current $I^{2}t \text{ for fusing Repetitive rate of rise of on-state current after triggering} $ $I^{2}t \text{ for fusing Repetitive rate of rise of on-state current after triggering} $ $I_{TM} = 12 \text{ A; } I_{G} = 0.2 $	Repetitive peak off-state voltages RMS on-state current Non-repetitive peak on-state current $I^{2}t \text{ for fusing Repetitive rate of rise of on-state current after triggering} $ $I^{2}t \text{ for fusing Repetitive rate of rise of on-state current after triggering} $ $I^{2}t \text{ for fusing Repetitive rate of rise of on-state current after triggering} $ $I_{TM} = 12 \text{ A}; I_{G} = 0.2 \text{ A}; $ $I_{TM} = 12 \text{ A}; I_{TM} = 0.2 \text{ A}; $ $I_{TM} = 12 \text{ A}; I_{TM} = 0.2 \text{ A}; $ $I_{TM} = 12 \text{ A}; I_{TM} = 0.2 \text{ A}; $ $I_{TM} = 12 \text{ A}; I_{TM} = 0.2 \text{ A}; $ $I_{TM} = 12 \text{ A}; I_{TM} = 0.2 \text{ A}; $ $I_{TM} = 12 \text{ A}; I_{TM} = 0.2 \text{ A}; $ $I_{TM} = 12 \text{ A}; I_{TM} = 0.2 \text{ A}; $ $I_{TM} = 12 \text{ A}; I_{TM} = 0.2 \text{ A}; $ $I_{TM} = 12 \text{ A}; I_{TM} = 0.2 \text{ A}; $ $I_{TM} = 12 \text{ A}; I_{TM} = 0.2 \text{ A}; $ $I_{TM} = 12 \text{ A}; I_{TM} = 0.2 \text{ A}; $ $I_{TM} = 12 \text{ A}; I_{TM} = 0.2 \text{ A}; $ $I_{TM} = 12 \text{ A}; I_{TM} = 0.2 \text{ A}; $ $I_{TM} = 12 \text{ A}; I_{TM} = 0.2 \text{ A}; $ $I_{TM} = 12 \text{ A}; I_{TM} = 0.2 $	Repetitive peak off-state voltages RMS on-state current Non-repetitive peak on-state current If the full sine wave; $T_{hs} \le 73^{\circ}\text{C}$ full sine wave; $T_{j} = 25^{\circ}\text{C}$ prior to surge to sur	Repetitive peak off-state voltages RMS on-state current Non-repetitive peak on-state current Non-state current $I_{\text{Non-repetitive peak on-state current}}$ full sine wave; $I_{\text{ns}} \leq 73^{\circ}\text{C}$ - full sine wave; $I_{\text{ns}} \leq 73^{\circ}\text{C}$ prior to surge $I_{\text{ns}} = 16.7\text{ms}$ - $I_{\text{ns}} = 16.7\text{ms}$ - $I_{\text{ns}} = 10\text{ms}$ - $I_{\text{ns}} = 10\text{ms}$ - $I_{\text{ns}} = 10\text{ms}$ - $I_{\text{ns}} = 10\text{ms}$ - $I_{\text{ns}} = 12\text{A}$; $I_{\text{ns}} = 1$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$

¹ Although not recommended, off-state voltages up to 800V may be applied without damage, but the triac may switch to the on-state. The rate of rise of current should not exceed 6 $A/\mu s$.

Philips Semiconductors Product specification

Triacs BT137X series

ISOLATION LIMITING VALUE & CHARACTERISTIC

 T_{hs} = 25 °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{isol}	R.M.S. isolation voltage from all three terminals to external heatsink	f = 50-60 Hz; sinusoidal waveform; R.H. ≤ 65%; clean and dustfree	-		2500	V
C _{isol}	Capacitance from T2 to external heatsink	f = 1 MHz	-	10	-	pF

THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
R _{th j-hs}	Thermal resistance junction to heatsink	full or half cycle with heatsink compound without heatsink compound	1 1		4.5 6.5	K/W K/W
R _{th j-a}	Thermal resistance junction to ambient	in free air	-	55	-	K/W

STATIC CHARACTERISTICS

T_i = 25 °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.			UNIT
		BT137X-				F	G	
I _{GT}	Gate trigger current	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}$ T2+ G+	_	5	35	25	50	l _{mA}
		T2+ G-	-	8	35	25	50	mA
		T2- G-	-	11	35	25	50	mA
	Lotobing ourront	T2- G+	-	30	70	70	100	mA
I _L	Latching current	$V_D = 12 \text{ V}; I_{GT} = 0.1 \text{ A}$ T2+ G+	_	7	30	30	45	mA
		T2+ G-	-	16	45	45	60	mA
		T2- G-	-	5	30	30	45	mA
I _H	Holding current	$V_D = 12 \text{ V}; I_{GT} = 0.1 \text{ A}$	- -	7 5	45 20	45 20	60 40	mA mA
V_T	On-state voltage	$I_{T} = 10 \text{ A}$	-	1.3		1.65	-	V
V _{GT}	Gate trigger voltage	$\dot{V}_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A} V_{D} = 400 \text{ V}; I_{T} = 0.1 \text{ A};$	- 0.25	0.7 0.4		1.5 -		V
I _D	Off-state leakage current	$T_{i} = 125 ^{\circ}C$ $V_{D} = V_{DRM(max)};$ $T_{i} = 125 ^{\circ}C$	-	0.1		0.5		mA

Triacs BT137X series

DYNAMIC CHARACTERISTICS

 $T_j = 25$ °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS		MIN.		TYP.	MAX.	UNIT
dV _D /dt	Critical rate of rise of off-state voltage	BT137X- $V_{DM} = 67\% V_{DRM(max)};$ $T_i = 125 °C;$ exponential	 100	F 50	G 200	250	-	V/μs
dV _{com} /dt	Critical rate of change of commutating voltage	waveform; gate open circuit $V_{DM} = 400 \text{ V}; T_j = 95 ^{\circ}\text{C};$ $I_{T(RMS)} = 8 \text{ A};$ $dI_{com}/dt = 3.6 \text{ A/ms}; gate$	-	-	10	20	-	V/μs
t _{gt}	Gate controlled turn-on time	open circuit $I_{TM} = 12 \text{ A}; V_D = V_{DRM(max)}; I_G = 0.1 \text{ A}; dI_G/dt = 5 \text{ A}/\mu s$	-	-	-	2	-	μs

Philips Semiconductors Product specification

Triacs BT137X series

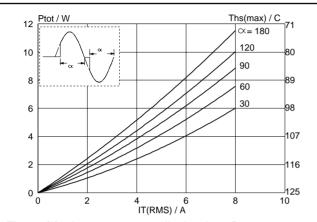


Fig.1. Maximum on-state dissipation, P_{tot} , versus rms on-state current, $I_{T(RMS)}$, where α = conduction angle.

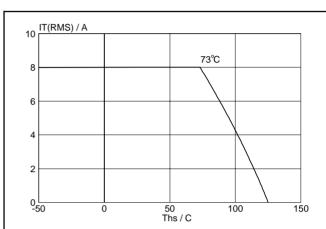


Fig.4. Maximum permissible rms current $I_{T(RMS)}$, versus heatsink temperature T_{hs} .

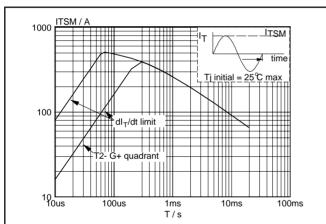


Fig.2. Maximum permissible non-repetitive peak on-state current I_{TSM} , versus pulse width t_p , for sinusoidal currents, $t_p \le 20$ ms.

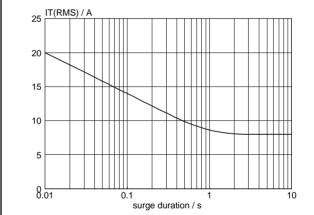


Fig.5. Maximum permissible repetitive rms on-state current $I_{T(RMS)}$, versus surge duration, for sinusoidal currents, f = 50 Hz; $T_{hs} \le 73$ °C.

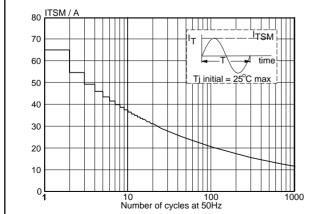


Fig.3. Maximum permissible non-repetitive peak on-state current I_{TSM} , versus number of cycles, for sinusoidal currents, f = 50 Hz.

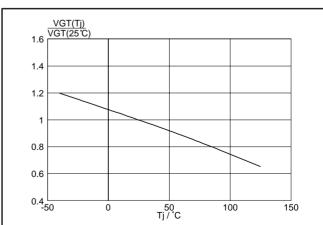
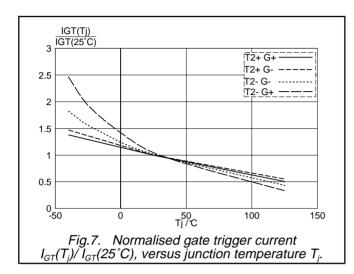


Fig.6. Normalised gate trigger voltage $V_{GT}(T_j)/V_{GT}(25^{\circ}C)$, versus junction temperature T_j .

Philips Semiconductors Product specification

Triacs BT137X series



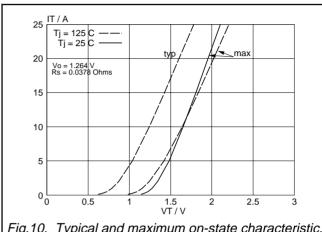
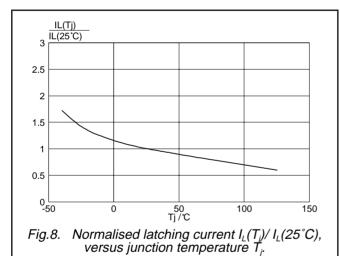
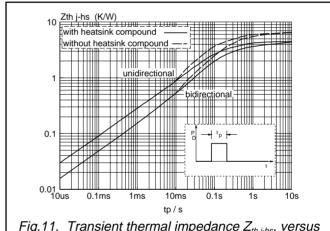


Fig. 10. Typical and maximum on-state characteristic.





IH(Tj) 3 IH(25°C) 2.5 0 -50 50 Tj /℃ 100 150

Fig.11. Transient thermal impedance Z_{th j-hs}, versus pulse width t_n.

off-state dV/dt limit

BT137 SERIES

BT137...F SERIES

Tj/C Fig.12. Typical commutation dV/dt versus junction temperature, parameter commutation dl₁/dt. The triac should commutate when the dV/dt is below the value on the appropriate curve for pre-commutation dI_{τ}/dt .

4.7

Fig.9. Normalised holding current $I_H(T_i)/I_H(25^{\circ}C)$, versus junction temperature T_i .

1000

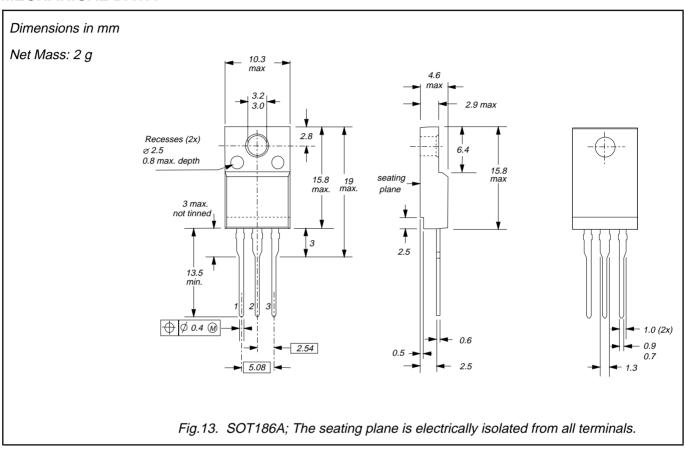
100

10

dlcom/dt 10 A/ms Philips Semiconductors Product specification

Triacs BT137X series

MECHANICAL DATA



- Notes
 1. Refer to mounting instructions for F-pack envelopes.
 2. Epoxy meets UL94 V0 at 1/8".

Philips Semiconductors Product specification

Triacs BT137X series

DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	

Limiting values

Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

© Philips Electronics N.V. 1999

All rights are reserved. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner.

The information presented in this document does not form part of any quotation or contract, it is believed to be accurate and reliable and may be changed without notice. No liability will be accepted by the publisher for any consequence of its use. Publication thereof does not convey nor imply any license under patent or other industrial or intellectual property rights.

LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.